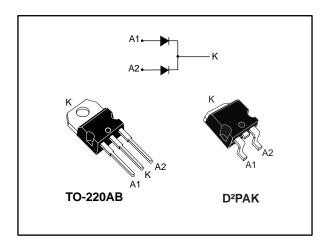
# life.augmented

# FERD40L60C

## 60 V field-effect rectifier diode

Datasheet - production data



#### **Features**

- ST advanced rectifier process
- Stable leakage current over reverse voltage
- Reduced leakage current
- Low forward voltage drop
- High frequency operation

## **Description**

The device is based on a proprietary technology that achieves the best in class  $V_F/I_R$  trade-off for a given silicon surface.

This 60 V rectifier has been optimized for use in confined applications where both efficiency and thermal performance are key.

This device is suitable for use in adapters and chargers.

**Table 1: Device summary** 

Symbol	Value
I <sub>F(AV)</sub>	2 x 20 A
V <sub>RRM</sub>	60 V
V <sub>F</sub> (typ.)	0.375 V
T <sub>j</sub> (max.)	150 °C

Characteristics FERD40L60C

### 1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, per diode, unless otherwise specified)

Symbol	Param	Value	Unit		
V <sub>RRM</sub>	Repetitive peak reverse voltage			60	V
I <sub>F(RMS)</sub>	Forward rms current			60	Α
	Average forward current $\delta = 0.5$ ,	T 400.00	Per diode	20	^
I <sub>F(AV)</sub>	square wave	T <sub>C</sub> = 130 °C	Per device	40	Α
I <sub>FSM</sub>	Surge non repetitive forward current	t <sub>p</sub> = 10 ms sinuso	250	Α	
T <sub>stg</sub>	Storage temperature range			-65 to +175	°C
Tj	Maximum operating junction temperature (1)			+150	°C

#### Notes:

**Table 3: Thermal resistance parameters** 

Symbol	Parameter	Max. value	Unit	
D	Junction to case	Per diode	1.3	
R <sub>th(j-c)</sub>	Junction to case	Per device	0.8	°C/W
R <sub>th(c)</sub>	Coupling		0.3	

Table 4: Static electrical characteristics, per diode

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 25 °C	$V_R = V_{RRM}$	-		1.1	mA
I <sub>R</sub> <sup>(1)</sup>		T <sub>j</sub> = 125 °C		-	40	80	
		T <sub>j</sub> = 125 °C	V <sub>R</sub> = 45 V	-	23	46	
	Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 4 A	-	0.32	0.36	
		T <sub>j</sub> = 125 °C		-	0.26	0.3	
V <sub>-</sub> (2)		T <sub>j</sub> = 25 °C		-	0.4	0.445	V
V F (-)		T <sub>j</sub> = 125 °C		-	0.375	0.425	V
		T <sub>j</sub> = 25 °C	I- 20 A	-	0.49	0.545	
		I <sub>F</sub> = 20 A	-	0.515	0.58		

#### Notes:

 $^{(1)}\text{Pulse}$  test:  $t_p$  = 5 ms,  $\delta$  < 2%

 $^{(2)} Pulse$  test:  $t_p$  = 380  $\mu s, \, \delta < 2\%$ 

To evaluate the conduction losses use the following equation:

 $P = 0.27 \text{ x } I_{F(AV)} + 0.0155 \text{ x } I_{F^2(RMS)}$ 

 $<sup>^{(1)}(</sup>dP_{tot}/dT_j) < (1/R_{th(j-a)})$  condition to avoid thermal runaway for a diode on its own heatsink.

FERD40L60C Characteristics

## 1.1 Characteristics (curves)

Figure 1: Average forward current versus ambient temperature ( $\delta$  = 0.5, per diode)

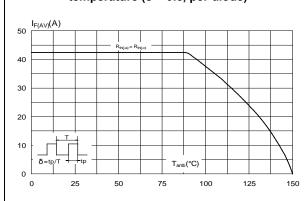


Figure 2: Relative variation of thermal impedance junction to case versus pulse duration

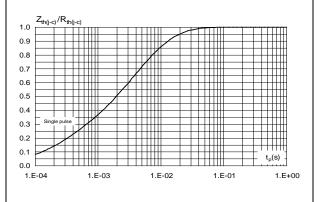


Figure 3: Reverse leakage current versus reverse voltage applied (typical values, per diode)

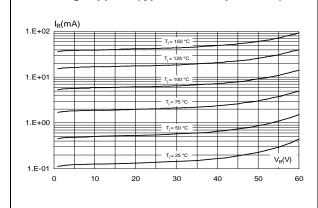


Figure 4: Junction capacitance versus reverse voltage applied (typical values, per diode)

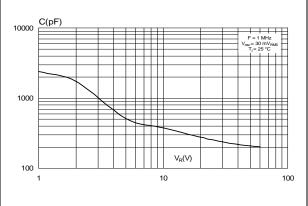


Figure 5: Forward voltage drop versus forward current (typical values, per diode)

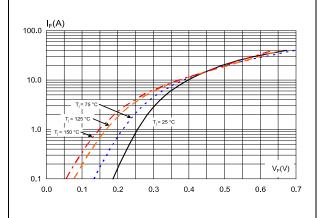
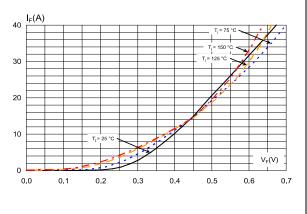
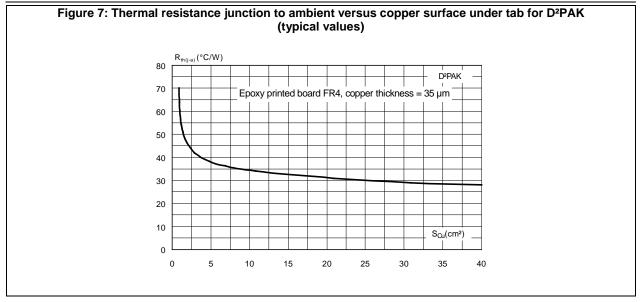


Figure 6: Forward voltage drop versus forward current (typical values, per diode)





Characteristics FERD40L60C



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FERD40L60C Package information

## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

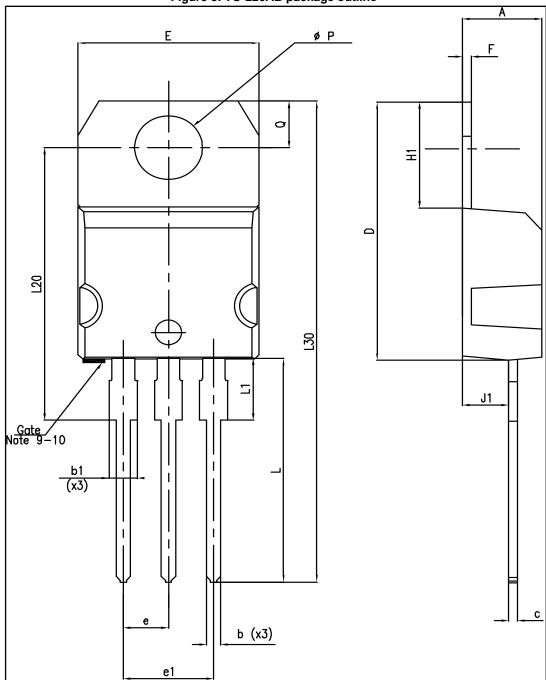
- Cooling method: by conduction (C)
- Epoxy meets UL94,V0
- Recommended torque value: 0.55 N·m (for TO-220AB)
- Maximum torque value: 0.6 N·m (for TO-220AB)



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# 2.1 TO-220AB package information

Figure 8: TO-220AB package outline



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Table 5: TO-220AB package mechanical data

		Dime	nsions	
Ref.	Millimeters		Inc	hes
	Min.	Max.	Min.	Max.
Α	4.40	4.60	0.173	0.181
b	0.61	0.88	0.024	0.035
b1	1.14	1.70	0.045	0.067
С	0.48	0.70	0.019	0.028
D	15.25	15.75	0.600	0.620
E	10.00	10.40	0.394	0.409
е	2.40	2.70	0.094	0.106
e1	4.95	5.15	0.195	0.203
F	0.51	0.60	0.020	0.024
J1	2.40	2.72	0.094	0.107
H1	6.20	6.60	0.244	0.256
L	13.00	14.00	0.512	0.551
L1	3.50	3.93	0.138	0.155
L20	16.40 typ.		0.646 typ.	
L30	28.90 typ.		1.1	38
Ø P	3.75	3.85	0.148	0.156
Q	2.65	2.95	0.104	0.116

# 2.2 D<sup>2</sup>PAK package information

Figure 9: D<sup>2</sup>PAK package outline

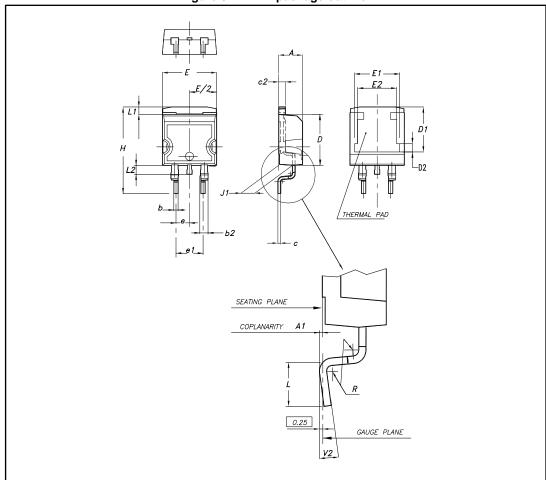
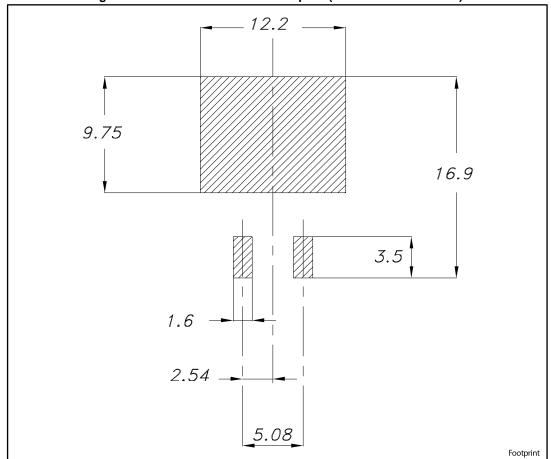


Table 6: D<sup>2</sup>PAK package mechanical data

	Dimensions					
Ref.	Millimeters				Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.40		4.60	0.173		0.181
A1	0.03		0.23	0.001		0.009
b	0.70		0.93	0.028		0.037
b2	1.14		1.70	0.045		0.067
С	0.45		0.60	0.018		0.024
c2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1	7.50	7.75	8.00	0.295	0.305	0.315
D2	1.10	1.30	1.50	0.043	0.051	0.060
E	10		10.40	0.394		0.409
E1	8.50	8.70	8.90	0.335	0.343	0.346
E2	6.85	7.05	7.25	0.266	0.278	0.282
е		2.54			0.100	
e1	4.88		5.28	0.190		0.205
Н	15		15.85	0.591		0.624
J1	2.49		2.69	0.097		0.106
L	2.29		2.79	0.090		0.110
L1	1.27		1.40	0.049		0.055
L2	1.30		1.75	0.050		0.069
R		0.4			0.015	
V2	0°		8°	0°		8°



Figure 10: D<sup>2</sup>PAK recommended footprint (dimensions are in mm)



FERD40L60C Ordering information

# 3 Ordering information

**Table 7: Ordering information** 

Order code	Marking	Package	Weight	Base qty.	Delivery mode
FERD40L60CTS	FD40L60CTS	TO-220AB	1.38 g	50	Tube
FERD40L60CG-TR	FD40L60CG	D²PAK	1.43 g	1000	Tape and reel

# 4 Revision history

**Table 8: Document revision history** 

Date	Revision	Changes
01-Sep-2017	1	Initial release.

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